

Masterclass | The State of the Art in Electronics

COMPANY OVERVIEW AND T&M, KEY AREAS OF INNOVATION

Prof. Dr. Ulrich L. Rohde

ROHDE & SCHWARZ

Make ideas real



MASTERCLASS

NOVEMBER CHAPTER

THE STATE OF ART IN ELECTRONICS

BY **Dr. ULRICH L. ROHDE**

PROFESSOR | AUTHOR | ENTREPRENEUR | ENGINEER

Join us for an insightful session on the State of Art in Electronics where innovation meets precision in the world of electronic design.

DETAILS OF THE SESSION

State of art in Electronics - higher density, lower power, SoCs

State of art in Communications - 5/6 G and LEO satellite communication

State of art in Testing & Measurement - R&S story

Systems engineering is critical for complex systems and role of software defined systems

Why and how you can be innovative?

The need and the process to be current in Technology - active participation in professional societies



Date : 18th November 2024

Time : 4 to 5:15PM

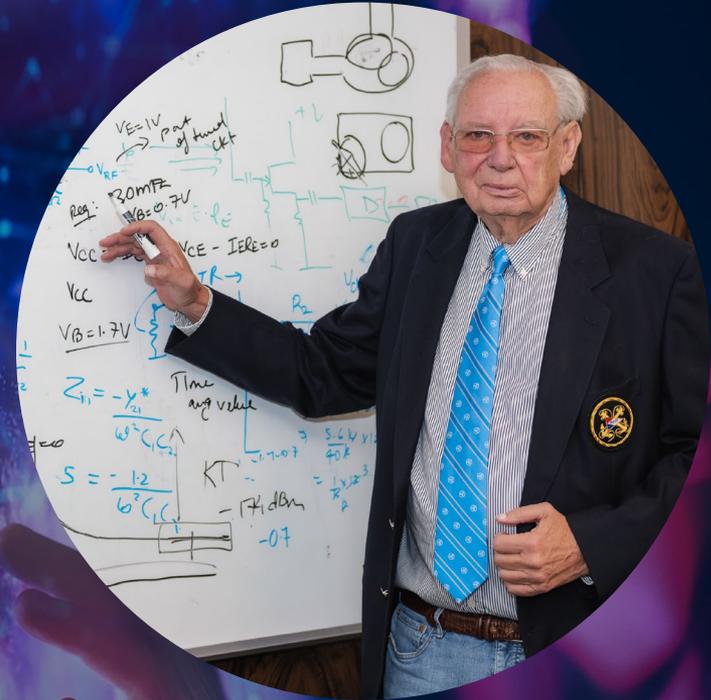
Teams invite will be shared separately



Ulrich L. Rohde

Prof. Dr.-Ing. habil., Dr. h.c. mult.

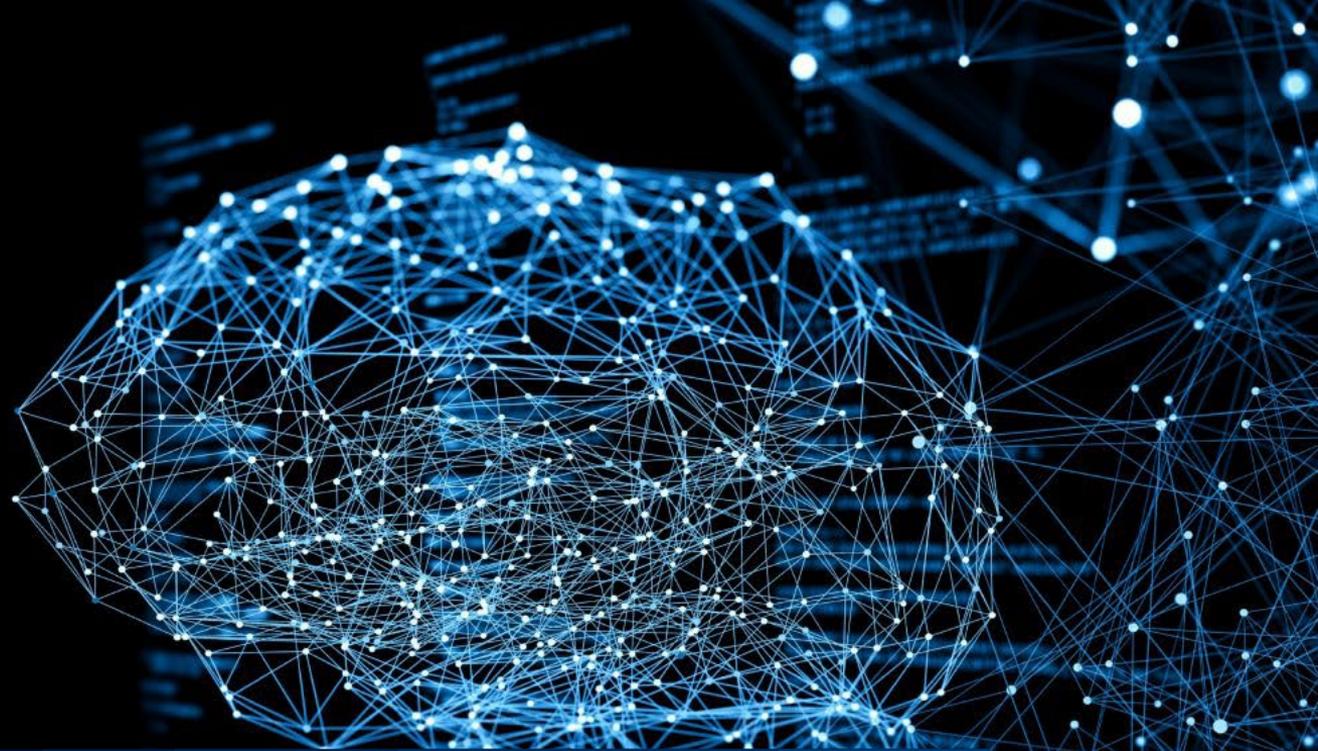
- Chair Professor for Microwave Technology at IIT-Jammu
- Professor of Microwave Technology at IIT-Delhi
- Professor of Microwave and RF at the BTU Cottbus-Senftenberg University of Technology, Germany
- Full professor of Radio & Microwave Theory & Techniques at the University of Oradea, Romania
- Professor at the German Armed Forces University Munich, Germany (Microwave Systems, Technical computer science)
- Honorary professor at several other universities worldwide
- Honorary member of the Bavarian Academy of Sciences, Germany
- Partner of Rohde & Schwarz, Germany
- Chairman of Synergy Microwave Corp., Paterson, NJ
- IEEE Life Fellow, <https://orcid.org/0009-0009-2271-4438>



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STATE OF THE ART IN ELECTRONICS HIGHER DENSITY, LOWER POWER, AND SOCS

KEY POINTS TO PONDER

Where do we come from?

Where are we today?

Where do we want to go?

An important principle: There are no free lunches!

Historical background:

- 1906: Lee de Forest invented the 'Audion' triode vacuum tube
- Enabled development of electronic oscillators and amplifiers
- Advantages of tubes: Thermal radiation, lax current limits, and robust power handling
- 1958: Jack Kilby (Texas Instruments) invented the Integrated Circuit (IC)

Evolution:

- Early systems used discrete components allowing circuit design flexibility
- 1958: Integrated Circuits (ICs) revolutionized electronics
- Modern ICs use nanometer-scale components with low voltages and ultra-low currents
- Today: Focus on System-on-Chip (SoC) for integrated digital and analog functions

State of the art technologies

- ▶ Gallium Nitride (GaN): High power density, overcoming frequency limitations
- ▶ Indium Phosphide (InP): Exceptional performance, sub-THz frequencies (>1 THz)
- ▶ Silicon Germanium (SiGe): High f_T (up to 700 GHz), ideal for optical and RF modules

Key metrics and performance

- ▶ GaN HEMT: Low noise figure (1 dB at 1 GHz), increasing to ~5 dB at 150 GHz
- ▶ ScALN/GaN HFETs: Up to 24% Power-Added Efficiency (PAE)
- ▶ InP HBTs: Operating at frequencies up to 340 GHz, $f_{max} > 1$ THz
- ▶ SiGe BiCMOS: f_T up to 700 GHz, essential for high-speed communications

Future directions & challenges

- ▶ Higher integration limits flexibility; relying on building blocks
- ▶ Foundry limitations and export controls impact new designs
- ▶ Cost-performance balance remains critical in advanced electronics
- ▶ Focus on scalable, energy-efficient designs for 5G/6G applications

A photograph of a modern office building complex with multiple stories, glass facades, and balconies. The building is surrounded by greenery and a clear blue sky. The image is used as a background for a presentation slide.

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COMPANY OVERVIEW AND T&M

ROHDE & SCHWARZ WHO WE ARE...

90 YEARS
OF ENSURING A SAFER AND
CONNECTED WORLD



We are
technology.



We innovate
and connect.



We thrive
independently.



Rohde & Schwarz

FROM A TWO-MAN LAB TO A PRIVATELY OWNED GLOBAL COMPANY

90+ years
of success

EUR 2.93 billion
revenue in FY 23/24

> 14,400
employees

15% to 20%
of revenue
invested in R&D



Rohde & Schwarz

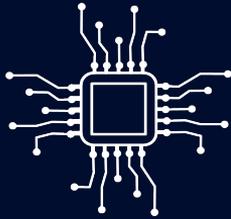
WE LIVE INNOVATION AND MASTER OUR WHOLE VALUE CHAIN



One out of four employees in R&D



~20% of turnover is invested in R&D



Investments in leading-edge technologies from development to production



Collaboration w/ academic & industry



High-Degree of vertical integration

New center for cutting-edge technology



ONE COMPANY – THREE DIVISIONS

TEST & MEASUREMENT



Wireless | Industry, Components & Research | Aerospace & Defense Testing | Automotive

TECHNOLOGY SYSTEMS



Secure Communications | SIGINT/Electronic Warfare | Monitoring & Analytics | Infrastructure & Networks | IP Network Analytics

NETWORKS & CYBERSECURITY



Endpoint & Mobile Security | Secure Networks | Certified & High Grade Crypto Solutions





RELIABILITY FOR OUR CUSTOMERS, INDEPENDENCE THROUGH VERTICAL INTEGRATION AND RELEVANCE FOR SUPPLIERS

- ▶ Strong flexibility to handle a wide variety of products and changing batch sizes
- ▶ Flexible and fast deliveries to customers all over the world
- ▶ Complexity management through investments in digitalization, automatization and innovative technologies (e.g. AI and robotics)
- ▶ Relevant for our suppliers through close corporations in diverse market segments



Rohde & Schwarz

SUSTAINABILITY AT ROHDE & SCHWARZ

The pursuit of sustainability has always been part of our identity. We have a responsible and value based corporate culture that is committed to acting sustainably – toward our employees, customers and partners as well as society and the environment.



R&S APPROACHES SUSTAINABILITY FROM VARIOUS ANGLES



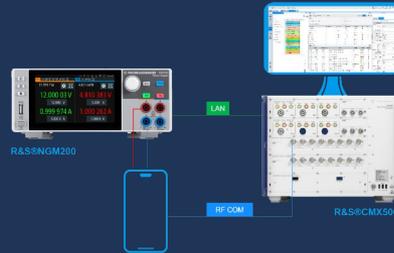
At our facilities



Analyse and improve, replace and optimize, avoid and reduce



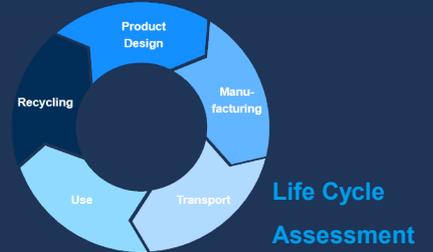
Part of our solutions



Test equipment to measure energy efficiency



Within our products



Approach over entire product lifecycle to improve environmental impact



OUR FACILITIES CONTRIBUTE TO OUR SUSTAINABILITY TARGETS

Usage of waste heat - Heat pumps for R&S data center (4 x 300 kW) in R&S Headquarters



Energy efficient combined heat and power plants (CHP) in our plant in Teisnach, GER



Solar panels in our plant in Memmingen, GER



Energy Software to monitor energy use in our plants



CLOSE TO THE MARKET. CLOSE TO CUSTOMERS.



- ▶ Locations in around 70 countries
- ▶ More than 60 subsidiaries
- ▶ Worldwide development centers, sales and service offices
- ▶ Rohde & Schwarz develops solutions for a wide range of customers in a variety of markets



TEST & MEASUREMENT

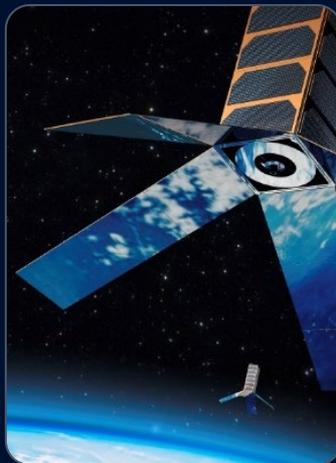


Wireless | Industry, Components &
Research | Aerospace & Defense Testing |
Automotive

Focus on
customer needs
along the
value chain.



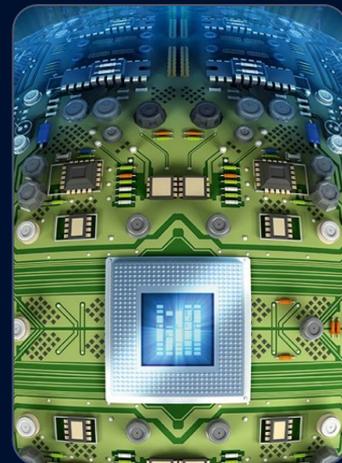
Wireless
Communication (WIC)



Aerospace & Defense
(ADT)



Automotive
(AUT)



Industrial Electronics,
Components,
Research &
Universities
(ICR)



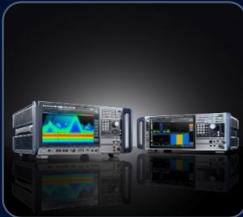
TEST & MEASUREMENT



Wireless | Industry, Components &
Research | Aerospace & Defense Testing |
Automotive



Mobile Radio
Testers



Spectrum &
Network
Analyzers,
EMC & Antenna
Test



Signal
Generators,
Power Supplies
& Meters



Microwave
Imaging



Oscilloscopes

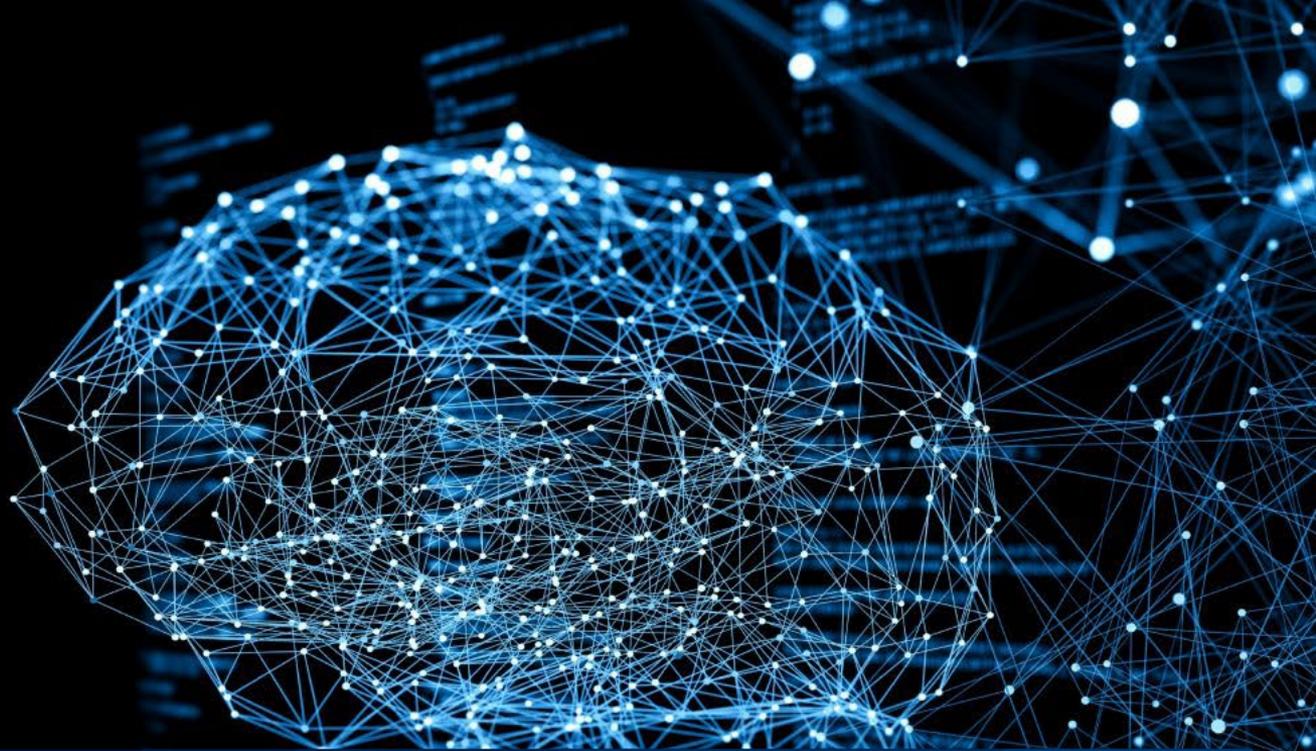


Zurich
Instruments



Service





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KEY AREAS OF INNOVATION

Staying **RELEVANT** through Innovation

Strong in-house expertise, partnerships and bolt-on technology acquisitions

Focus on today's and tomorrow's cutting-edge technologies



 **research** is emerging



Demand for **faster Wi-Fi** with low latency



High speed **Digital Design**

Higher **defense budgets** worldwide



Strong **new space** and **NTN** business



For autonomous driving more
and more (radar) sensors



Electrification and **high-voltage** solutions
getting more important

T&M Market Trends



WE CONNECT THE WIRELESS ECOSYSTEM! WITH OUR PEOPLE, EXPERTISE AND INNOVATIVE SOLUTIONS



Translate > Consolidate > Standardize > Independent Reference





5G
ADVANCED



MOBILE
EXPERIENCE

ENABLING
CONNECTIONS,
EMPOWERING
INNOVATION.

Test & measurement solutions from the everyday to the extraordinary



CONNECTING
EVERYTHING



TOWARDS 6G



QualiPoc/Freerider

Benchmarker

PR200

FPH44

TSME6/TSMA6



SMW



FSW



PVT360



CMW500



CMX500



CMP200



CMP180 Flex



RTP



Test System



OTA Chamber



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5G FROM TERRESTRIAL TO SPACE

3GPP CALL IT NON TERRESTRIAL NETWORKS (NTN)



DIFFERENT IMPLEMENTATIONS OF NTN – DEVICE ASPECTS

3GPP VS. PROPRIETARY

PROPRIETARY NTN

Apple Globalstar LEO

HUAWEI TIANGTONG THURAYA GEO

QUALCOMM Iridium LEO

StarNet

3GPP >Rel.17 NB-NTN/NR-NTN

skylo TECHNOLOGIES

Viasat GEO ECHOSTAR GEO

Globalstar LEO TIANGTONG GEO

Iridium LEO QO TECHNOLOGY

INTELSAT MEO SES MEO

IRIS2 LEO

3GPP unmodified Direct to Device/Cell/Handset

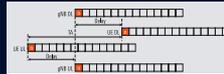
T-Mobile STARLINK LEO

AST SpaceMobile AT&T Verizon LEO

amazon project kuiper LEO

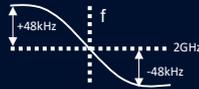
NTN USER EQUIPMENT ESSENTIAL REQUIREMENTS AND CHALLENGES

Time Synchronization



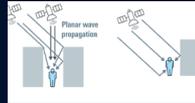
Long delay and time variant delay: Distance, UE to satellite causes long absolute delay (~40 ms for LEO and 544 ms for GEO). Orbital movement of satellite will cause a time variant delay during the connection time. Variable RTT due to Elevation angle and LEO, SIB31 K_mac (RTT calc), K_offset, SIB32, SIB19.

Frequency Synchronization



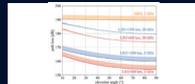
Doppler shift: Movements of LEO satellites causes a time and elevation angle variant Doppler shift.

Signal Fading



Fading profiles: Beside the legacy terrestrial fading profiles, satellite connectivity requires new fading profiles such as the combination of atmospheric and terrestrial fading as well as the emulation of weather specific effects (rain, cloud, sun storms causing electron flow).

Minimum SINR



High attenuation and low SNR: The large distance causes a high free space path loss ending in a low SNR at the UE side. Minimum SINR ≥ -10 dB, minimum RSRP ≥ -137 dBm.

GNSS Measurements and Satellite Ephemerals



GNSS emulation and provisioning of ephemeris information in the first approach, NTN targets at outdoor connections, UE is capable of GNSS and determines its terrestrial position. The UE is pre-provisioned with the orbit information (ephemeris) via SIB broadcast.

Power Saving Optimizations



Cell Acquisition, mandatory GNSS, cell search, eDRX/PSM (start time of upcoming coverage info, repetitions in low CQI, UE to predict discontinuous coverage based on the satellite assistance information, SIB32).

NTN BANDS AND FREQUENCY



2023

R17

2026/2027

R18

2029/2030

R19 prospect

NTN-IoT@2GHz (S/L)

NTN-NR@2GHz (S/L)

NTN-NR@17-30GHz (K-Ka)

NTN-NR@12-16GHz (Ku)

narrowband

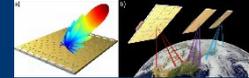
wideband

broadband

Antenna profiles

- 23dBm
- Linear polarization
- Patch, FDD

- 33dBm
- 60cm circular polarization
- Active Phased Array FDD/TDD



Device Types

Handheld, IoT, Wearable, AUT/TCU

CPE, TCU, VSAT

Speed

~200kbps (200KHz BW)

~1-2mbps (5MHz-30MHz BW)

~200mbps (~400MHz BW)

Service

Small data/one way voice?

Data/voice

Data broadband/voice

Usecases



SATELLITE ORBIT: LEO

Altitude: 160-2000 km
Orbital time: 1.5 – 2 h
Total Latency: 2-27 ms
Sat. Velocity: 7.8 - 8.2 km/s

LEO

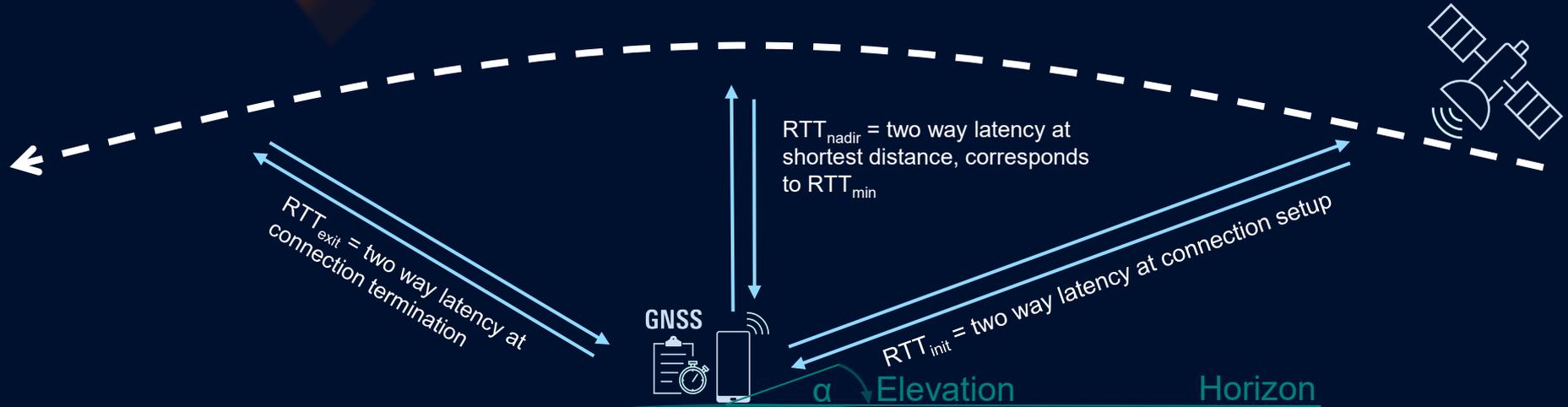
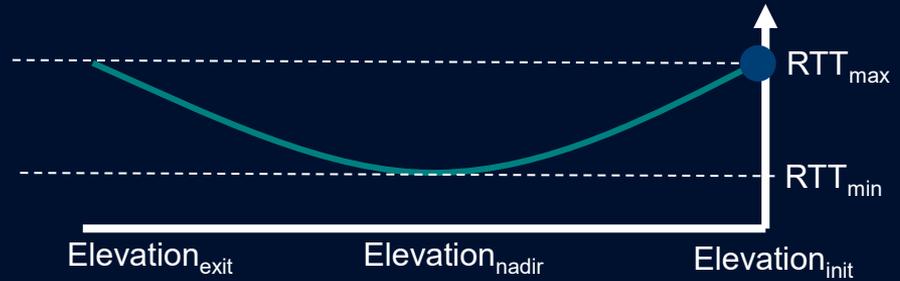


ROUND TRIP TIME

GNSS



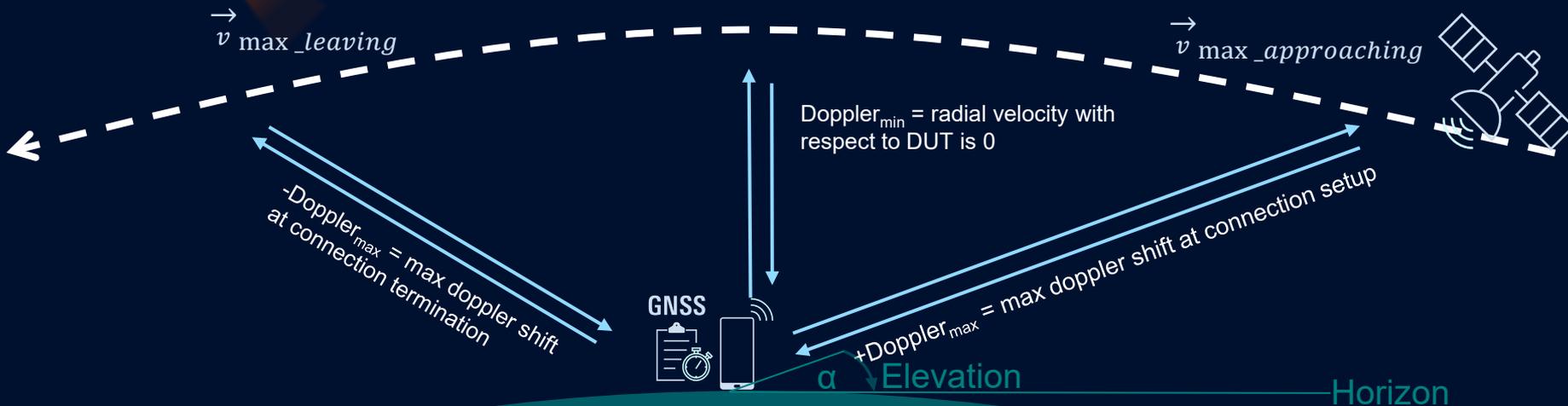
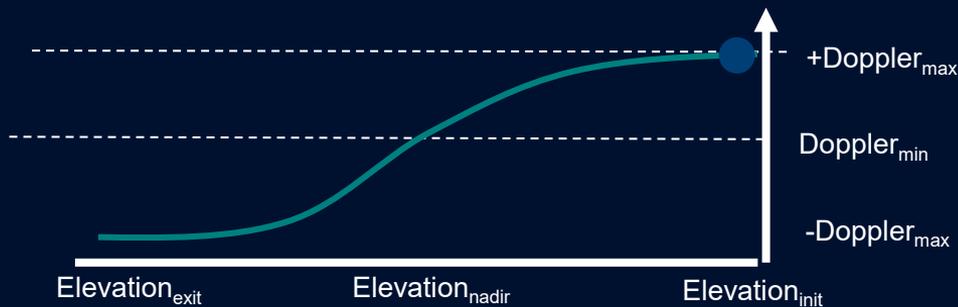
GNSS optionally used by
LEO for orbit control



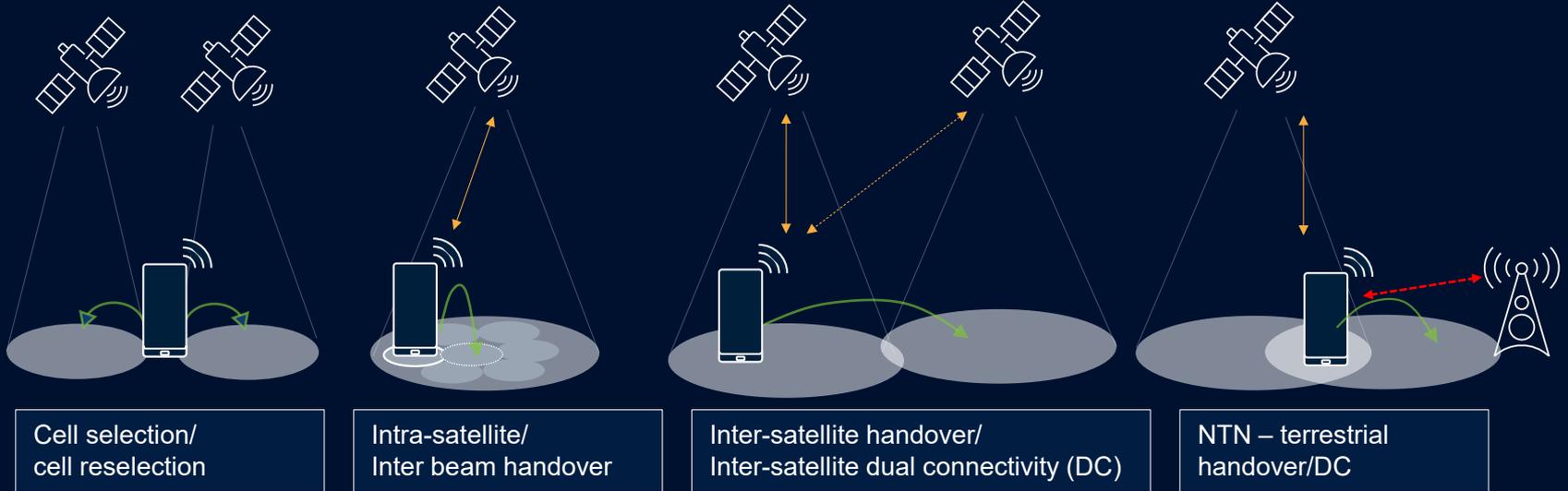
DOPPLER



GNSS optionally used by LEO for orbit control



MOBILITY SCENARIOS



NR-NTN connection



Target or simultaneous dual connectivity NR-NTN connection



Target or simultaneous dual connectivity terrestrial connection

From 5G to 6G

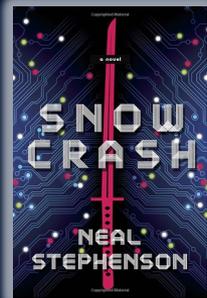
Evolution of the mobile wireless standards and frequencies

Application richness,
Complexity &
Efficiency



WHAT IS THE METAVERSE? AND WHAT IS IT FOR?

An immersive, pervasive, interconnected virtual 3D world shaped by extended reality applications where many people can gather to work, shop, play, and socialize, facilitated by virtual reality (VR) and augmented reality (AR) headsets via cloud computing.



The origin of the term Metaverse is in Neal Stephenson's novel "Snow Crash"

Collaboration



Digital
Twins



Training
Education
Healthcare



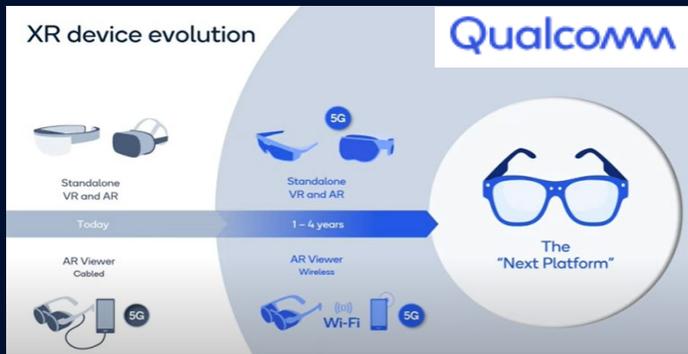
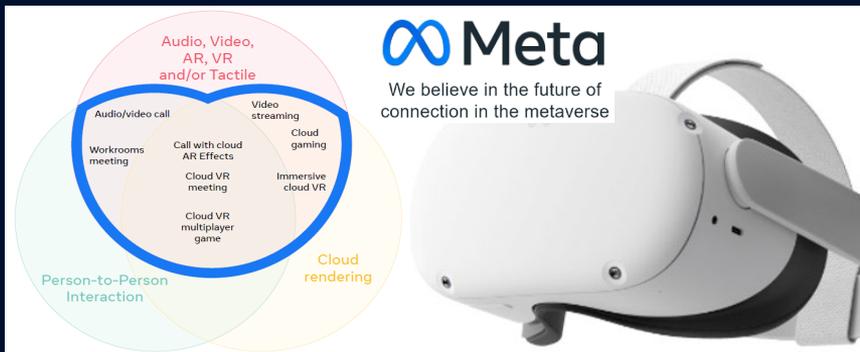
Gaming
Social



A selection, there are many others...

METaverse IS ON THE AGENDA OF ALL INDUSTRY PLAYERS

INDUSTRIAL METaverse NOW, ENTERPRISE & CONSUMER FOLLOW



ERICSSON

6G - Connecting a cyber-physical world

EuCNC & 6G Summit
Wednesday June 7
9:45-10:30
Kongresshallen

The slide features a background image of a person wearing a futuristic AR/VR headset with glowing blue and red elements.

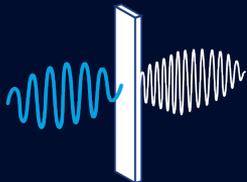




Research areas from an T&M perspective

6G introduces many new technology components

Spectrum for 6G:
"FR3" and THz



Integrated sensing &
communication



Artificial Intelligence
and Machine
Learning



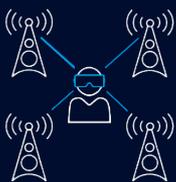
Reconfigurable
Intelligent Surfaces



Photonics, Visible
Light
Communication



New network
topologies,
distributed
computing



Multiple access,
new waveforms,
channel coding



Ultra-massive
MIMO



The Metaverse and
eXtended Reality
(XR)



Full-duplex
communication

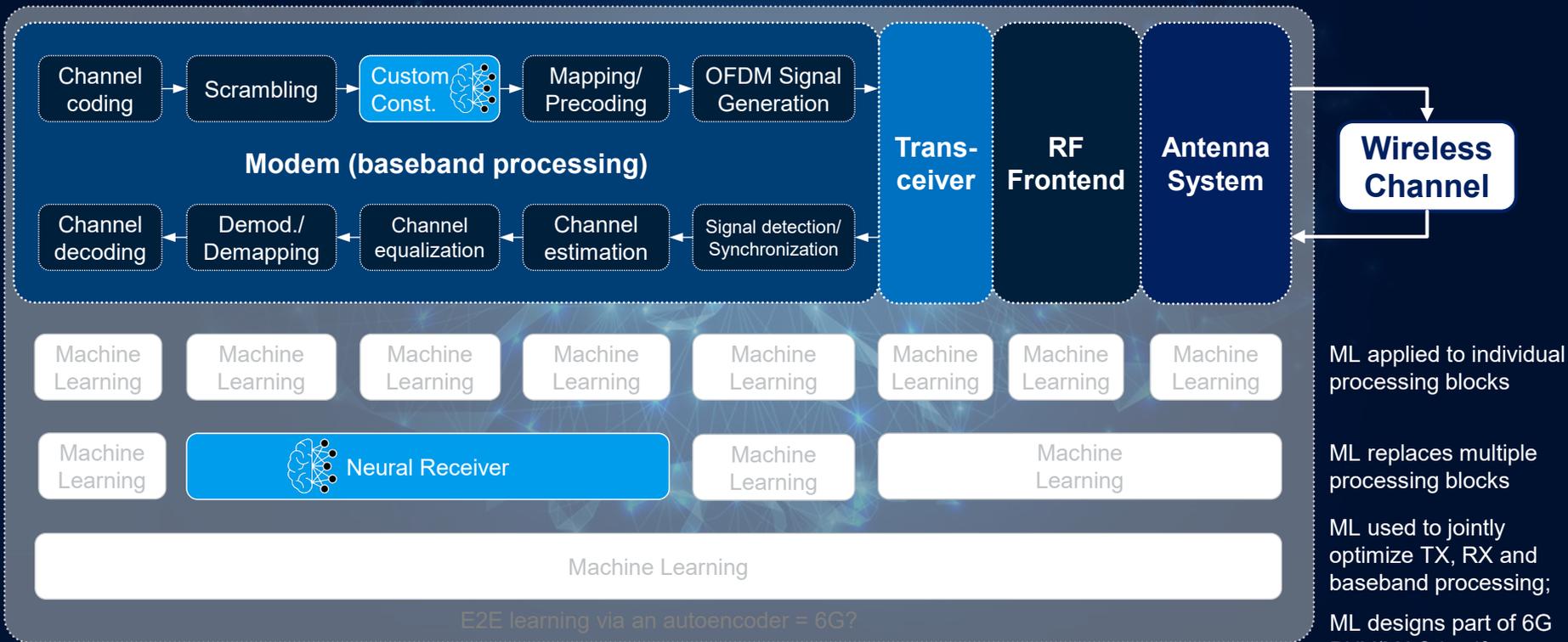


Security &
Trustworthiness

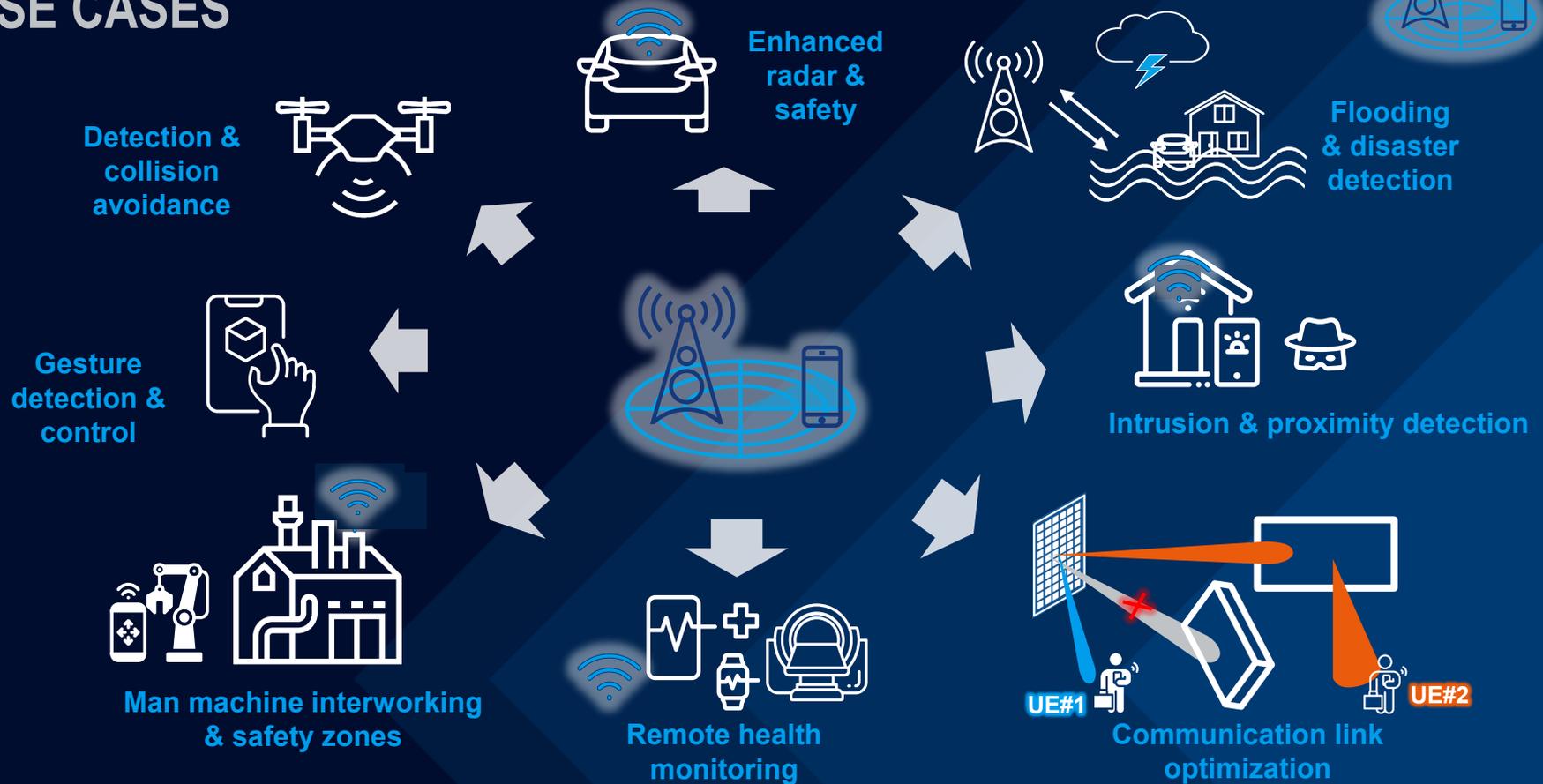


TOWARDS AN AI-NATIVE AIR INTERFACE FOR 6G

ENHANCING THE NEURAL RECEIVER WITH CUSTOM CONSTELLATION



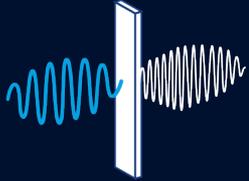
INTEGRATED SENSING AND COMMUNICATION USE CASES





RESEARCH AREAS FROM A T&M PERSPECTIVE

THz communication,
and "FR3"



Integrated sensing
& communication



Artificial Intelligence
and Machine Learning



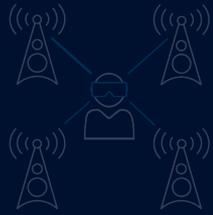
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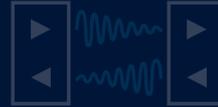
Multiple access,
new waveforms,
channel coding



Ultra-massive
MIMO



New network topologies,
distributed computing



Full-duplex
communication

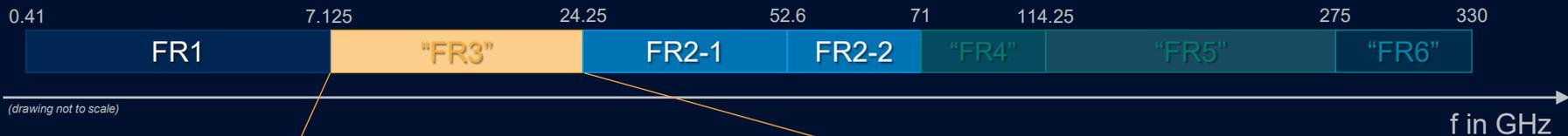


Security &
Trustworthiness



SPECTRUM CONSIDERATIONS FOR 6G

IS FR3 SPECTRUM FOR 5G-ADVANCED OR 6G OR BOTH?



- 6.1.6 Potential Spectrum bands for study
 - 6.1.6.1 UHF Band
 - 6.1.6.1.1 1300-1350 MHz
 - 6.1.6.1.2 1780-1850 MHz
 - 6.1.6.2 Lower-cmW spectrum
 - 6.1.6.2.1 3100-3450 MHz
 - 6.1.6.2.2 3980-4180 MHz (TBD)
 - 6.1.6.2.3 4400-4940 MHz
 - 6.1.6.2.4 7125-8500 MHz
 - 6.1.6.3 Upper-cmW spectrum
 - 6.1.6.3.1 10-10.5 GHz
 - 6.1.6.3.2 10.7-12.2
 - 6.1.6.3.3 12.2 – 12.7 GHz
 - 6.1.6.3.4 12.7-13.75 GHz
 - 6.1.6.3.5 13.75-15 GHz
 - 6.1.6.3.6 25.25-27.5 (TBD)
 - 6.1.6.4 EHF Band
 - 6.1.6.4.1 37.0-37.6 GHz
 - 6.1.6.4.2 42-43.5 (TBD)
 - 6.1.6.4.3 92-114.25 GHz (W-band) and 122.25-174.8 GHz (D-band):

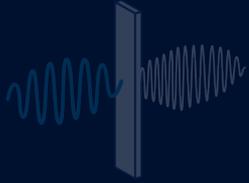


- ▶ Status after WRC-23 –
New study items for input for WRC-27:
 - 4400 to 4800 MHz (in EMEA and APAC)
 - 7125 to 8400 MHz (excluding 7250 to 7750 MHz in Europe due to use by NATO)
 - 14.8 to 15.35 GHz
- ▶ Notable regional activities
 - FCC studies 12.7 to 13.25 GHz,



RESEARCH AREAS FROM A T&M PERSPECTIVE

THz communication,
and "FR3"



Integrated sensing
& communication



Artificial Intelligence
and Machine Learning



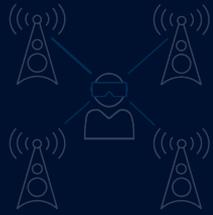
Reconfigurable
Intelligent Surfaces



Photonics, Visible
Light Communication



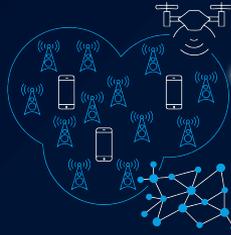
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New network topologies,
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Full-duplex
communication



Security &
Trustworthiness



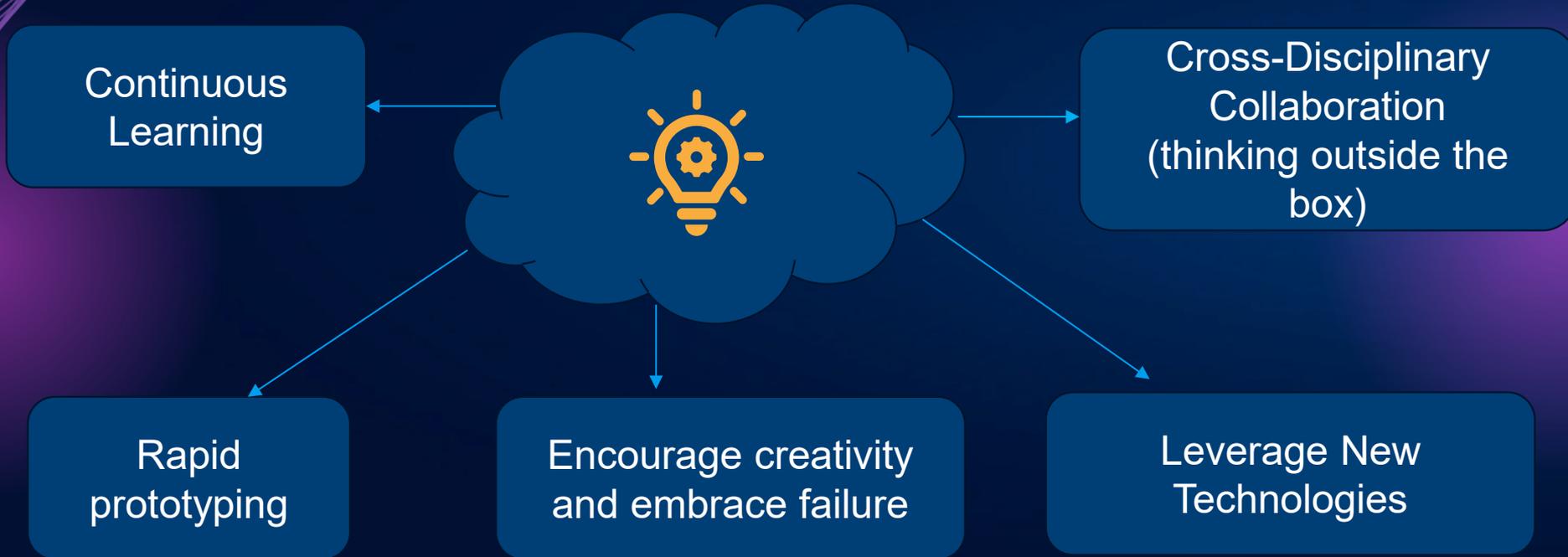
SUMMARY

- ▶ Deployment of 5G networks is in full swing, although it is still a long way to go to reach its full capabilities and deliver on its promises.
- ▶ Meanwhile, researchers in academia and industry are exploring new technology components to make 6G networks and devices **more efficient, intelligent, sustainable, and secure**
- ▶ These new, challenging technology components will enable the next step towards an **immersive, pervasive, digital experience** in a hyper-connected world

WHY SHOULD YOU BE INNOVATIVE?



HOW COULD YOU BE INNOVATIVE?



THE NEED AND THE PROCESS TO BE CURRENT IN TECHNOLOGY

Rapid technological advancements

Competitive edge

Career growth
(employers value engineers who are
proactive)

Problem solving skills



ACTIVE PARTICIPATION IN PROFESSIONAL SOCIETIES



Please read:

<https://builtin.com/hardware/moores-law>

Important references:

- IEEE microwave Magazine for the Microwave & Wireless Engineer Volume 25 - Number 10 October 2024 ISSN 1527-3342 features.
- Walker, J. Fundamentals of Physics, 8th ed., John Wiley and Sons, 2008, p. 891. ISBN 9780471758013 (Wien's displacement law).

ROHDE & SCHWARZ

Make ideas real

Thank you for your attention!

